

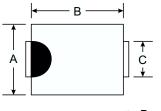
1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

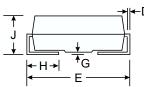
Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly

Mechanical Data

- Case: Molded Plastic
- Case Material UL Flammability Rating Classification 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Terminals: Solder Plated Terminal Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number & Date Code: See Below
- Ordering Information: See Below
- Weight: 0.064 grams (approx.)





SMA						
Dim	Min	Max				
Α	2.29	2.92				
В	4.00	4.60				
С	1.27	1.63				
D	0.15	0.31				
E	4.80	5.59				
G	0.10	0.20				
Н	0.76	1.52				
J	2.01	2.62				
All Dimensions in mm						

Maximum Ratings and Electrical Characteristics @ TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic		Symbol	ES1A	ES1B	ES1C	ES1D	ES1G	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	50	100	150	200	400	V
RMS Reverse Voltage		V _{R(RMS)}	35	70	105	140	280	V
Average Rectified Output Current	@ T _T = 110°C	lo	1.0			Α		
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load (JEDEC Method)		I _{FSM}	30				А	
Forward Voltage Drop	@ I _F = 0.6A @ I _F = 1.0A	V _{FM}	0.90 — 0.98 —		1.25	V		
Peak Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 100°C	I _{RM}	5.0 200			μА		
Reverse Recovery Time (Note 1)		t _{rr}	20				ns	
Typical Total Capacitance (Note 2)		Ст	10				pF	
Typical Thermal Resistance, Junction to Terminal (Note 3)		$R_{\theta JT}$	40				°C/W	
Operating and Storage Temperature Range		T _{j,} T _{STG}	-65 to +150				°C	

Ordering Information (Note 4)

Device*	Packaging	Shipping
ES1x-13	SMA	5000/Tape & Reel

Notes:

- 1. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See figure 5.
- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pad as heat sink.
- 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- *x = Device type, e.g. ES1A-13.

Marking Information



XXXX = Product type marking code, ex. ES1A Oll = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002 WW = Week code 01 to 52

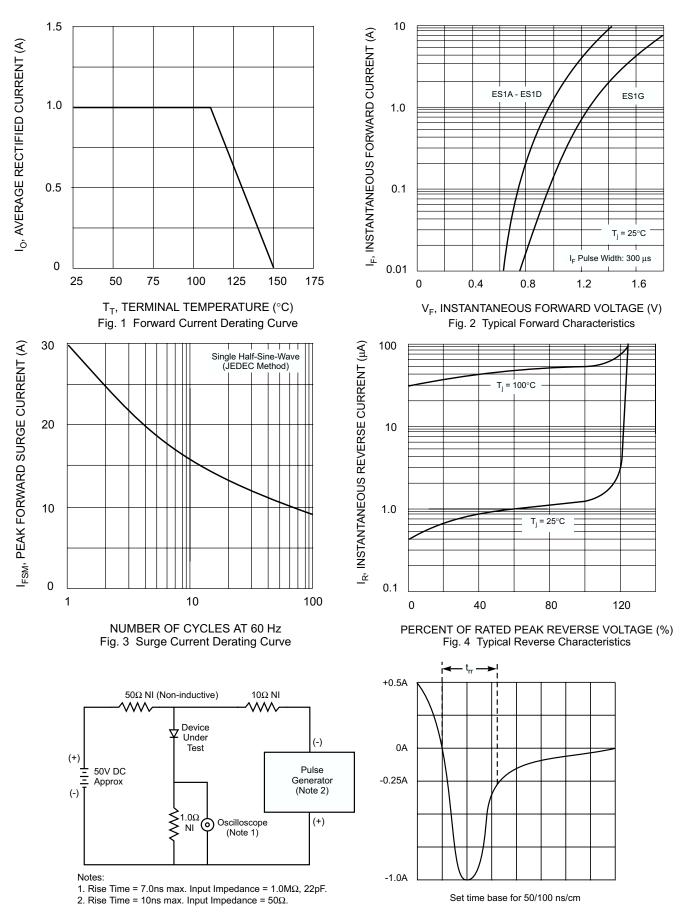


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit